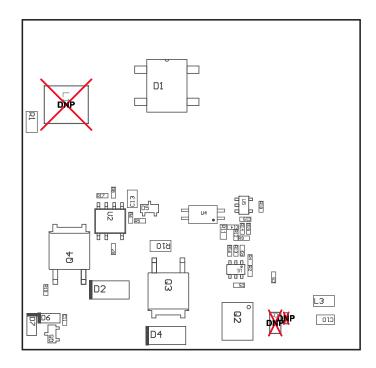


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10936	REV: C	SVN REV:	: Not In VersionControl
IGNORE ->				
PLOT NAME = Top Assembly Drawing	GENERATED : 7/25/2	2015 8:55:56	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10936	REV: C	SVN REV: Not In VersionControl			
	IGNORE ->					
PLOT NAME = Bottom Assembly Drawing	GENERATED : 7/25/2	2015 8:55:57	PM	TEXAS INSTRUMENTS		

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